

FEATURES

Low Profile Package
Ideal For Automated Placement
Glass passivated chip junction
High Forward Surge Capability
Meet AEC-Q101 Requirements



APPLICATIONS

For Use In General Purpose Rectification Of Power Supplies,	
Inverters, Converters, And Freewheeling Diodes For Consumer,	
And Telecommunication	

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

MAXIMUM RATINGS AND CHARACTERISTICS ($T_A = 25$ °C)

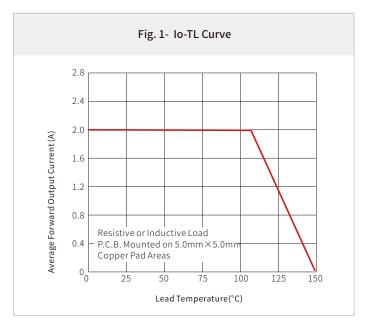
Parameter		Symbol	GS2A AQ	GS2B AQ	GS2D AQ	GS2G AQ	GS2J AQ	GS2K AQ	GS2M AQ	Unit
Marking			GS2AA	GS2BA	GS2DA	GS2GA	GS2JA	GS2KA	GS2MA	
Maximum Repetitive peak reverse vo	oltage	V_{RRM}	50	100	200	400	600	800	1000	
Maximum RMS Voltage		V_{RMS}	35	70	140	280	420	560	700	V
Maximum DC Blocking Voltage		V _{DC}	50	100	200	400	600	800	1000	
Average rectified output current @60Hz sine wave, Resistance load, T	L (FIG.1)	I _o				2				
Forward Surge Current (Non-Repetitive) @60Hz Half-sine Wave,1 cycle, Tj=25°C Forward Surge Current (Non-Repetitive)		I _{FSM}				50 100				А
@1ms, square Wave, 1 cycle, Tj=25°C Maximum Instantaneous Forward Voltage I _{FM} =2.0A		V _F	1.1						V	
Maximum DC Reverse Current at		·	5						•	
Rated DC Blocking Voltage	T _J =125°C	- I _R	100						μΑ	
Typical Junction Capacitance Measured at 1MHz and Applied Reverse Voltage Of 4.0 V.D.C		C _J	12						pF	
Current squared time @1ms≤t≤8.3ms Tj=25°C		l²t	10.735						A ² s	
Typical Thermal Resistance ⁽¹⁾		$R_{\theta J-A}$				65				
		R _{0J-L}				20				°C/W
		$R_{\theta J-C}$				18				
Operating junction and storage temperature range		T_J , T_{STG}			-55	to +150				°C

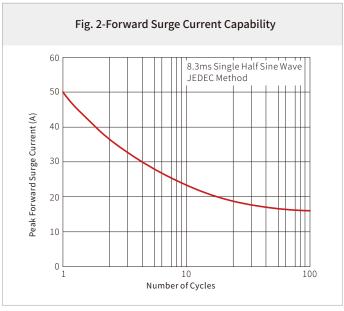
Note

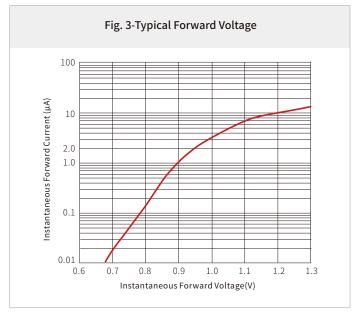
⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead mounted on P.C.B. with 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

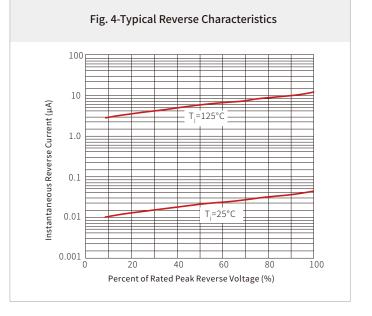


CHARACTERISTIC CURVES





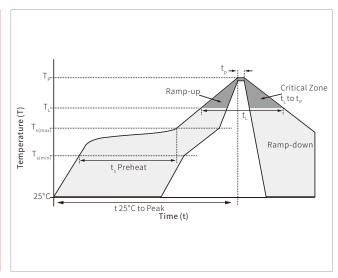




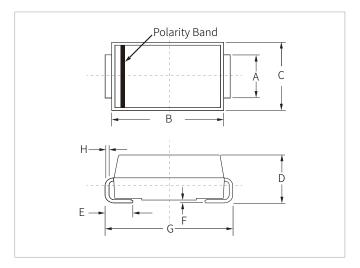


SOLDERING PARAMETERS

	Lead-free assembly	
	Temperature Max $(T_{s(min)})$	150°C
Pre Heat	Temperature Max (T _{s(max)})	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average ran	np up rate (Liquidus Temp (T_L) to peak	3°C/second max
	3°C/second max	
Reflow	Temperature (T_L) (Liquidus)	217°C
Renow	Time (min to max) (t_L)	60 – 150 seconds
Peak Temp	erature (T _P)	260°C
Time within	20 – 40 seconds	
Ramp-dow	6°C/second max	
Time 25°C t	8 minutes max.	
Do not exce	260°C	



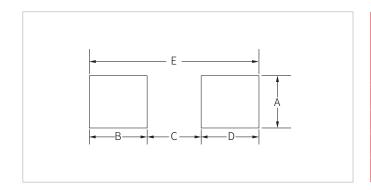
DO-214AC(SMA) PACKAGE INFORMATION



Ref.	Millin	neters	Inc	nes
itel.	Min.	Max.	Min.	Max.
А	1.20	1.60	0.047	0.063
В	4.20	4.60	0.165	0.181
С	2.40	2.80	0.094	0.110
D	2.00	2.40	0.079	0.094
Е	0.76	1.52	0.030	0.060
F	0.02	0.20	0.001	0.008
G	4.85	5.25	0.191	0.207
Н	0.15	0.30	0.006	0.012



RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Millim	neters	Inches		
KCI.	Min.	Мах.	Min.	Мах.	
А	1.63	-	0.064	-	
В	1.45	-	0.057	-	
С	-	2.80	-	0.090	
D	1.45	-	0.057	-	
E	5.28REF		0.20	8REF	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
GS2AAQ-GS2MAQ	DO-214AC(SMA)	5000PCS	13"



Headquarters

No.3387 Shendu Road Pujiang I&E Park Minhang Shanghai China 201000

Hotline 400-021-5756

Web

Https://www.semiware.com

Sales Center

Tel: 86-21-3463-7458

Email: sales18@semiware.com

Customer Service

Tel: 86-21-5484-1001

Email: sales17@semiware.com

Technical Support

Tel: 86-21-3463-7654

Email: fae01@semiware.com

Complaint & Suggestions

Tel: 86-21-3463-7172

Ext: 8868

Email: cs03@semiware.com

By QR Code





Website

Machai

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